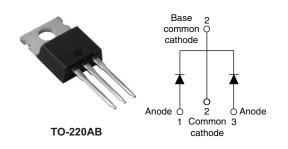
Vishay High Power Products

High Performance Schottky Generation 5.0, 2 x 8 A



2 x 8 A

100 V

0.58 V

PRODUCT SUMMARY

I_{F(AV)}

 V_{R}

V_F at 8 A at 125 °C

SHA

FEATURES

- 175 °C high performance Schottky diode
- Very low forward voltage drop
- Extremely low reverse leakage
- Optimized V_F vs. I_R trade off for high efficiency
- · Increased ruggedness for reverse avalanche capability
- RBSOA available
- Negligible switching losses
- Submicron trench technology
- Full lead (Pb)-free and RoHS compliant devices
- Designed and qualified for industrial level

APPLICATIONS

- High efficiency SMPS
- Automotive
- High frequency switching
- Output rectification
- Reverse battery protection
- Freewheeling
- Dc-to-dc systems
- Increased power density systems

MAJOR RATINGS AND CHARACTERISTICS							
SYMBOL	YMBOL CHARACTERISTICS VALUES UNITS						
V _{RRM}		100	N/				
V _F	8 Apk, $T_J = 125 \ ^{\circ}C$ (typical, per leg)	0.55	v				
TJ	Range	- 55 to 175	°C				

VOLTAGE RATINGS					
PARAMETER	SYMBOL	TEST CONDITIONS	16CTT100	UNITS	
Maximum DC reverse voltage	V _R	T _J = 25 °C	100	V	

ABSOLUTE MAXIMUM RATINGS						
PARAMETER	SYMBOL	TEST CONDITIONS		VALUES	UNITS	
Maximum average per leg		50 % duty cycle at T_C = 163 °C, rectangular waveform		8		
forward current per device	I _{F(AV)}			16		
Maximum peak one cycle		5 μs sine or 3 μs rect. pulse	Following any rated load	850	A	
non-repetitive surge current per leg	I _{FSM}	10 ms sine or 6 ms rect. pulse	condition and with rated V _{RRM} applied	210		
Non-repetitive avalanche energy per leg	E _{AS}	$T_J = 25 \text{ °C}, I_{AS} = 1.5 \text{ A}, L = 60 \text{ mH}$		67	mJ	
Repetitive avalanche current per leg	I _{AR}	Limited by frequency of operation and time pulse duration so that $T_J < T_J$ max. I_{AS} at T_J max. as a function of time pulse See fig. 8		I _{AS} at T _J max.	А	



COMPLIANT

Vishay High Power Products

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ELECTRICAL SPECIFICATIONS						
PARAMETER	SYMBOL	TEST CONDITIONS		TYP.	MAX.	UNITS
Forward voltage drop per leg	V _{FM} ⁽¹⁾	8 A	T _J = 25 °C	-	0.72	v
		16 A		-	0.85	
		8 A	T.I = 125 °C	-	0.58	
		16 A	1j=125 C	-	0.69	
	I _{RM} ⁽¹⁾	T _J = 25 °C	$V_{\rm B}$ = Rated $V_{\rm B}$	-	65	μA
Reverse leakage current per leg		T _J = 125 °C	V _R = naleu V _R	-	4	mA
Junction capacitance per leg	CT	V_{R} = 5 V_{DC} (test signal range 100 kHz to 1 MHz) 25 $^{\circ}\text{C}$		520	-	pF
Series inductance per leg	L _S	Measured lead to lead 5 mm from package body		8.0	-	nH
Maximum voltage rate of change	dV/dt	Rated V _R		-	10 000	V/µs

Note

 $^{(1)}$ Pulse width < 300 $\mu s,$ duty cycle < 2 %

THERMAL - MECHANICAL SPECIFICATIONS						
PARAMETER		SYMBOL	TEST CONDITIONS	VALUES	UNITS	
Maximum junction and storage temperature rang	e	T _J , T _{Stg}		- 55 to 175	°C	
Maximum thermal resistance, junction to case per leg Maximum thermal resistance, junction to case per device		R _{thJC} DC	DC operation	2		
				1	°C/W	
Typical thermal resistance case to heatsink	9,	R _{thCS}	Mounting surface, smooth and greased	0.5		
Approvimate weight				2	g	
Approximate weight				0.07	oz.	
Mounting torque	minimum			6 (5)	kgf · cm	
Mounting torque	maximum			12 (10)	(lbf · in)	
Marking device			Case style TO-220AB (JEDEC)	16CT	T100	



High Performance Vishay High Power Products Schottky Generation 5.0, 2 x 8 A

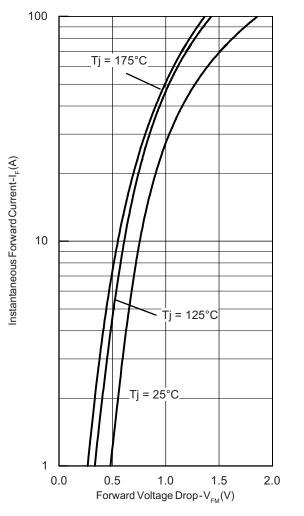


Fig. 1 - Maximum Forward Voltage Drop Characteristics

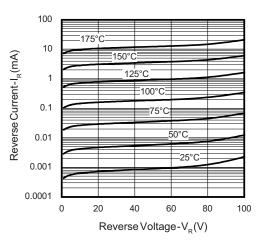


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage

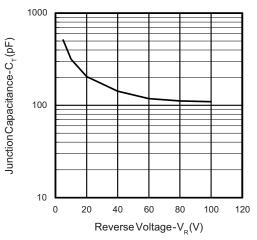
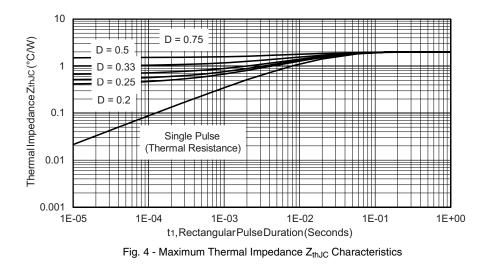


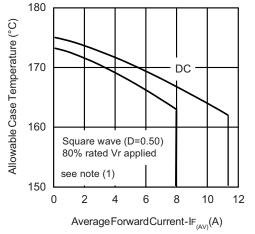
Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

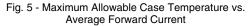


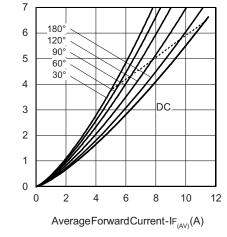


Vishay High Power Products **High Performance** Schottky Generation 5.0, 2 x 8 A

Average Power Loss-(Watts)









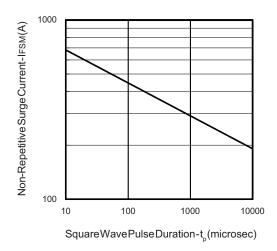


Fig. 7 - Maximum Non-Repetitive Surge Current

Note

⁽¹⁾ Formula used: $T_C = T_J - (Pd + Pd_{REV}) \times R_{thJC}$; Pd = Forward power loss = $I_{F(AV)} \times V_{FM}$ at $(I_{F(AV)}/D)$ (see fig. 6); $Pd_{REV} =$ Inverse power loss = $V_{R1} \times I_R$ (1 - D); I_R at $V_{R1} = 80$ % rated V_R



High Performance Vishay High Power Products Schottky Generation 5.0, 2 x 8 A

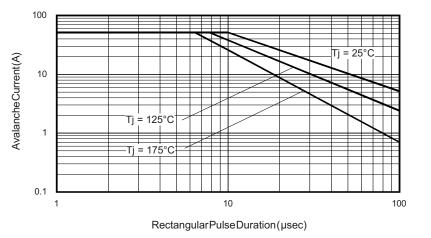
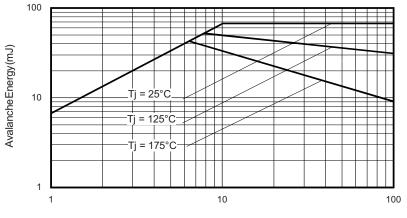


Fig. 8 - Reverse Bias Safe Operating Area (Avalanche Current vs. Rectangular Pulse Duration)



RectangularPulseDuration(µsec)

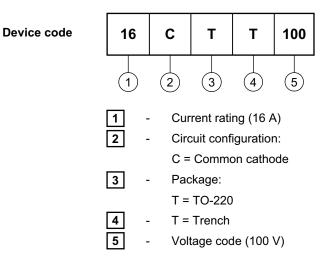
Fig. 9 - Reverse Bias Safe Operating Area (Avalanche Energy vs. Rectangular Pulse Duration)

Vishay High Power Products

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ORDERING INFORMATION TABLE



Tube standard pack quantity: 50 pieces

LINKS TO RELATED DOCUMENTS					
Dimensions http://www.vishay.com/doc?95222					
Part marking information	http://www.vishay.com/doc?95225				
SPICE model	http://www.vishay.com/doc?95229				



Vishay Semiconductors

TO-220AB

DIMENSIONS in millimeters and inches





.ead	assignments

Diodes

1. - Anode/open 2. - Cathode 3. - Anode

SYMBOL	MILLIMETERS		INCHES		NOTES
STIVIDUL	MIN.	MAX.	MIN.	MAX.	NOTES
А	4.25	4.65	0.167	0.183	
A1	1.14	1.40	0.045	0.055	
A2	2.56	2.92	0.101	0.115	
b	0.69	1.01	0.027	0.040	
b1	0.38	0.97	0.015	0.038	4
b2	1.20	1.73	0.047	0.068	
b3	1.14	1.73	0.045	0.068	4
С	0.36	0.61	0.014	0.024	
c1	0.36	0.56	0.014	0.022	4
D	14.85	15.25	0.585	0.600	3
D1	8.38	9.02	0.330	0.355	
D2	11.68	12.88	0.460	0.507	6

Notes

- ⁽¹⁾ Dimensioning and tolerancing as per ASME Y14.5M-1994
- ⁽²⁾ Lead dimension and finish uncontrolled in L1
- ⁽³⁾ Dimension D, D1 and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body
- $^{\left(4\right) }$ Dimension b1, b3 and c1 apply to base metal only
- (5) Controlling dimensions: inches
- (6) Thermal pad contour optional within dimensions E, H1, D2 and E1

MILLIMETERS INCHES SYMBOL NOTES MIN. MAX. MIN. MAX. 10.51 0.414 10.11 0.398 3,6 Е E1 6.86 8.89 0.270 0.350 6 E2 0.76 0.030 7 --2.41 2.67 0.095 0.105 е 0.208 e1 4.88 5.28 0.192 H1 6.09 6.48 0.240 0.255 6,7 13.52 14.02 0.532 0.552 L L1 3.32 3.82 0.131 0.150 2 ØΡ 3.54 3.73 0.139 0.147 2.60 0.102 Q 3.00 0.118 90° to 93° 90° to 93° θ

Conforms to JEDEC outline TO-220AB

- (7) Dimensions E2 x H1 define a zone where stamping and singulation irregularities are allowed
- (8) Outline conforms to JEDEC TO-220, except A2 (maximum) and D2 (minimum) where dimensions are derived from the actual package outline



Vishay

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